

## C0603X169C2TAC7411

SMD Comm X8G HT150C Flex, Ceramic, 1.6 pF, +/-0.25 pF, 200 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0603, 0.4 mm



Click here for the 3D model.

| General Information      |  |
|--------------------------|--|
| Series                   | SMD Comm X8G HT150C Flex                     |
| Style                    | SMD Chip                                     |
| Description              | SMD, MLCC, High Temperature,<br>Ultra-Stable |
| Features                 | High Temperature, Ultra-Stable               |
| RoHS                     | Yes  |
| Termination              | Flexible Termination                         |
| Marking                  | No   |
| AEC-Q200                 | No   |
| Typical Component Weight | 4.6 mg                                       |
| Shelf Life               | 78 Weeks                                     |
| MSL                      | 1  |

 Dimensions

 Chip Size
 0603

 L
 1.6mm +/-0.17mm

 W
 0.8mm +/-0.15mm

 T
 0.8mm +/-0.15mm

 S
 0.4mm MIN

 B
 0.45mm +/-0.15mm

## Packaging SpecificationsPackagingT&R, 330mm, Paper TapePackaging Quantity15000

| Specifications   |  |
|--|--|
| Capacitance  | 1.6 pF   |
| Measurement Condition  | 1 MHz 1.0Vrms                                      |
| Tolerance  | +/-0.25 pF   |
| Voltage DC   | 200 VDC  |
| Dielectric Withstanding Voltage  | 500 VDC  |
| Temperature Range  | -55/+150°C   |
| Temp. Coefficient  | X8G  |
| Capacitance Change with<br>Reference to +25°C and 0 VDC<br>Applied (TCC) | 30 ppm/C, 1MegaHz 1.0Vrms                          |
| Dissipation Factor   | 0.1% 1 MHz 1.0Vrms                                 |
| Aging Rate   | 0% Loss/Decade Hour: Referee<br>Time is 1000 Hours |
| Insulation Resistance  | 100 GOhms  |

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